

SAGI RAMA KRISHNAM RAJU ENGINEERING COLLEGE (AUTONOMOUS)

(Affiliated to JNTUK, Kakinada), (Recognized by AICTE, New Delhi) UG ProgrammesCE,CSE,ECE,EEE,IT & ME are Accredited by NBA CHINNA AMIRAM (P.O):: BHIMAVARAM :: W.G.Dt., A.P., INDIA :: PIN: 534 204

Estd:1980

LIST OF OPEN ELECTIVES OFFERED BY VARIOUS DEPARTMENTS TO OTHER DEPARTMENTS IN

IV YEAR II SEMESTER

Offered by	Course Code	Course Name	Offered to
	B19CEOE05	Alternative energy sources	CSE, ECE, IT & ME
CIVIL ENGINEERING	B19CEOE06	Intelligence Transport System	CSE, ECE, EEE, IT & ME
COMPUTER SCIENCE &	B19CSOE07	Machine Learning	CE, ECE, EEE & ME
ENGINEERING	B19CSOE08	Internet of Things	CE & ME
ENGINEEKING	B19CSOE09	Operating Systems	CE, ECE, EEE & ME
6.14			
ELECTRONICS &	B19ECOE05	Internet of Things	CE & ME
COMMUNICATION	D10ECOE06	VI SL degion	FFF
ENGINEERING	B19ECOE06	VLSI design	EEE
	ENG	INFEDING COLLE	CE
ELECTRICAL & 1980	B19EEOE01	Introduction to Electrical Systems	CE, CSE & IT
ELECTRONICS	B19EEOE04	Basic Power Electronics	ECE & ME
ENGINEERING	B19EEOE06	MATLAB Programming for Engineering Applications	CE, CSE, IT & ME
INFORMATION	B19ITOE05	Cloud Computing	CE, ECE, EEE & ME
TECHNOLOGY	B19ITOE06	Internet of Things	CE & ME
	B19MEOE05	Mechatronics	CE, CSE, ECE, EEE & IT
MECHANICAL	B19MEOE06	Green Energy Systems	CE, CSE, ECE & IT
ENGINEERING		Micro-Electro Mechanical	CE, CSE, ECE, EEE &
	B19MEOE07	Systems	IT

С	ode	Category	L	Т	Р	C	I.M	E.M	Exam			
B19CE	COE05	OE	3			3	25	75	3 Hrs.			
		A	LTER	NATIV	E ENER	GY SO	URCES					
				(Off	ered by	CE)						
			(Off	ered to (CSE, EC	E, IT &	k ME)					
Course	Objecti	ves:										
1	Explain the concepts of Non-renewable and renewable energy systems											
2			of rene	ewable of	energy s	sources	for bot	h domestic a	nd industrial			
	applicat			1 1		•	<u> </u>	1.1	· · ·			
3	-	e the enviro ison with foss			cost eco	nomics	of ren	ewable energy	sources in			
	compar		sii iueis	•								
Course	Outcom	es: At the end	d of the	course \$	tudente	will he	able to					
									Knowledge			
S.No				Out	come				Level			
1	summar	ize the need of	of renew	vable sou	rces in C	Global s	cenario		K2			
2	explain	the solar there	nal con	version	processe	s			K2			
3	explain	the wind ener	gy con	version to	echnique	s			K2			
4	explain	the biomass e	nergy c	conversio	on metho	dologies	S		K2			
5	explain	the principle	of ocea	n therma	l energy	convers	ion syste	m	K2			
	2	std. 1980				NNAN	IOUS					
					LLABU							
UNIT (10 Ha	rs) ene rs) lene Use rene	rgy sources - e, Energy for	need & sustain icity ar	develop able dev nd key e	ment of velopmer elements	renewał nt - Pote - Glob	ole energ ential of al clima	conventional y sources - Fut renewable ene te change - C s.	ure of Energy rgy sources -			
UNIT (10 H	-II and	Estimation -	Solar 7	Thermal (Conversi	on Devi	ices and	Availability - Storage - Appl tems.				
	 Photovoltaic Conversion, applications of solar energy systems. Wind Energy: Wind Energy Conversion - Site selection, Types of wind turbines, wind Generation and Control. Nature of the wind, , factors influencing wind, wind data and energy estimation, wind speed monitoring, classification of wind characteristics, applications of wind turbines, offshore wind energy – Hybrid systems wind resource assessment, Betz limit, site selection, wind energy conversion devices Windmill component design, economics and demand side management, energy wheeling, and energy banking concepts. Safety and environmental aspects, wind energy potential and installation in India. 											

		Biogas: Calorific value and composition of biogas – Bio energy systems – Biomass						
UNIT	-IV	conversion processes – Thermo chemical conversion processes – biomass gasification						
(10 H	lrs)	- pyrolysis - liquefaction - anaerobic digestion - Urban waste to energy conversion -						
		bio diesel production – Biomass energy programme in India.						
		Ocean Energy - Principle of Ocean Thermal Energy Conversion (OTEC) - tidal						
UNI	Г-V	energy conversion – Scheme of development of tidal energy						
(10 H	lrs)	Hydro power plants- types of turbines – estimation of primary and secondary power						
		Geothermal Energy – Geothermal power plants						
Fext B	ooks:							
1	Not	n-Conventional Energy Sources by G.D.Rai						
2	Tw	idell, J.W. and Weir, A., Renewable Energy Sources, EFN Spon Ltd., 1986.						
Refere	nce B	ooks:						
1	Kis	hore VVN, Renewable Energy Engineering and Technology, Teri Press, New Delhi,						
	2012							
2	Go	dfrey Boyle, Renewable Energy, Power for a Sustainable Future, Oxford University						
		ss, U.K., 1996.						
	1							



(Code	Category	L	Т	Р	С	I.M	E.M	Exam
B19	CEOE06	OE	3			3	25	75	3 Hrs.
							•		
		INTE	LLIGE	NCE TI	RANSP	ORT SY	STEM		
				(Offer	ed by C	E)			
		(0	ffered to	CSE, I	ECE, E	EE, IT &	ME)		
Cours	se Objectiv	es:							
1	To know	the fundamental	s of ITS						
2	-	sensor technolog			-	nts of ITS			
3	To know	ITS functional a	reas and	user ser	vices				
4	•	various kinds of							
5	To study	ITS applications	in vario	us fields	s of tran	sportation	n enginee	ring	
Cours	se Outcom	es: At the end of	the course	Student	s will be	able to			
S.No				Outcon	ıe				Knowledge
1	Idontify th	a han afita of IT	T from w	mions tr	1000	-			Level K2
$\frac{1}{2}$		e benefits of ITS		-	·	a aollaati	on taahni	anac	K2 K3
2		various sensor S user services				a conectio	Sh techin	ques	K3 K3
<u> </u>		various ITS mo				and ITS	nlanning		K3 K4
4		the suitable IT							
5		tion Problems.		ology a			cettvenes	5 10 50170	K4
		std. 1980				L LYJE (LYL			
				SYL	LABUS	1			
UNIT (8 Hr	-I publi	lamentals of IT c policy and ma fits of ITS.							
Sensor technologies and Data requirements of ITS: Importance telecommunications in the ITS system, Information Management, Traffic Manageme Centres (TMC). Application of sensors to Traffic management; Traffic flow sense technologies; Transponders and Communication systems; Data fusion at traffi management centres; Sensor plan and specification requirements; Elements of Vehic Location and Route Navigation and Guidance concepts; ITS Data collection technique – Detectors, Automatic Vehicle Location (AVL), Automatic Vehicle Identification (AVI), GIS, video data collection.									
UNIT (8 Hi	-III Trave	functional area eler. Information unced Vehicle C	on syste	ms (A'	TIS), C	Commerci	al Vehi	cle Opera	tions (CVO),

	(APTS), Advanced RuralTransportation systems (ARTS). ITS User Needs and Services							
	- Travel and Traffic management, Public Transportation Management, Electronic							
	Payment, Commercial Vehicle Operations, Emergency Management, Advanced Vehicle							
	safety systems, Information Management.							
	ITS Architecture – Regional and Project ITS architecture; Concept of operations; ITS							
UNIT-IV	Models and Evaluation Methods; Planning and human factor issues for ITS, Case							
	studies on deployment planning and system design and operation; ITS and safety, ITS							
(8 Hrs)	and security, ITS as a technology deployment program, research, development and							
	business models, ITS planning.							
	ITS Applications: Traffic and incident management systems; ITS and sustainable							
	mobility, travel demand management, electronic toll collection, ITS and road-pricing.;							
	Transportation network operations; commercial vehicle operations and intermodal							
UNIT-V	freight; public transportation applications; ITS and regional strategic transportation							
(8 Hrs)	planning, including regional architectures: ITS and changing transportation institutions							
(0 1115)	Automated Highway Systems- Vehicles in Platoons – Integration of Automated							
	Highway Systems ITS Programs in the World – Overview of ITS implementations in							
	developed countries, ITS in developing countries.							
Text Bool								
1								
1	Fundamentals of intelligent transportation systems planning ByMashrur A. Chowdhury, Adel WadidSadek.							
2								
2	ITS Hand Book 2000: Recommendations for World Road Association (PIARC) by Kan							
Dß	Paul Chen, John Miles. <u>AUTONOMOUS</u>							
Reference								
1	Sussman, J. M., Perspective on ITS, Artech House Publishers, 2005.							
2	National ITS Architecture Documentation, US Department of Transportation, 2007.							

	Code	Category	L	Т	Р	С	I.M	E.M	Exam				
B190	CSOE07	OE 3 0 0 3 25 75							3 Hrs.				
			M	ACHIN	NE LEA	ARNIN	G						
				(Offer	red by	CSE)							
			(Offere	d to CI	E, ECE	, EEE &	& ME)						
Course	Objective	s:											
1.		uce the basic c	-		•			0					
2.		To demonstrate regression, classification and clustering methods.											
3.	To introduce the concepts of dimensionality reduction, artificial neural networks and												
		reinforcement learning To show the application of machine learning model evaluation and optimization techniques											
4.	To show t	the application	n of mac	thine lea	arning 1	nodel ev	valuation	and optim	ization techniques				
<u></u>	0.1	A1 1 .	C .1	C .	1.								
Course	Outcomes	: At the end of	t the co	urse Stu	idents v	vill be a	ble to		TZ 1. 1				
S.No				Outc	ome				Knowledge Level				
	Formulat	e the concep	ts of	ingredie	ents an	d preli	minaries	of mach					
1.	learning	e the concep	15 01 1	ingreate	Jito un	a prem		or mach	K3				
2.	0	e models, line	ar mode	els and o	distance	e-based	models		K3				
3.		ind construct f			100 C			1	K3				
4		rate the conce					on techr	niq <mark>ue</mark> s, mo	del K2				
4.	evaluation	n and selectior	n techni	ques	IEEI	RINC	i CO	LLEGE	K3				
5.	Apply the	e concepts of a	rtificial	neural	networ	ks, reinf	orcemen	t learning	К3				
	i Base i set												
				SY	LLAB	US							
		-			_		-		g a learning system				
		Issues in machine learning, Types of machine learning, Tasks : the problems that can be											
TINIT		solved with machine learning, Models : the output of machine learning											
UNI7 (12 H		C											
(12 П	-	s) Preliminaries: The curse of dimensionality, Overfitting, Training, Tes sets, The confusion matrix, The accuracy metrics : Accuracy, sensiti											
						•		•	ve Bayes Classifier				
	-	e basic statist							ve Dayes Classifier				
						,							
	Tree	Models: Dec	ision Tı	ees.									
	Line				ares me	ethod: U	Univaria	te linear r	regression, Logisti				
TINIT		Regression Support vector machines (Except Logistic regression others Peter Fla											
UNIT	-II Regr	ression, Suppo	(B) Distance Based Models: Introduction, Nearest Neighbours classified										
UNIT (10 H	-II Regr					-	-	-					

UNIT (10 H	
UNIT (08 H	
UNI7 (10 H	Multilayer percentron in practice. Examples of using MLP
Text B	aaks
1.	Introduction to Machine Learning, Alpaydin E, MIT Press (2014) 3rdEdition
2.	Machine Learning: The art and science of algorithms that make sense of data, Peter Flach, Cambridge, 2012
3.	Machine Learning: An algorithmic perspective, Stephen Marsland, 2nd edition, CRC press, 2014.
4.	Python Machine Learning Cookbook-Practical Solutions from Preprocessing to Deep Learning, Chris Albon, Oreilly, 2018.
Refere	nce Books:
1.	The elements of statistical learning, Data Mining, Inference and Prediction, Trevor Hastie, Robert Tibshirani, Jerome Friedman, Second edition, Springer, 2009.
2.	Machine Learning in Action, Peter Harington, 2012, Cengage.
3.	Python Machine Learning: Machine Learning and Deep Learning with Python, scikit-learn, Tensorflow, Sebastian Raschka, Vahid Mirjalili, Second edition, 2020
Online	MOOC Courses:
1.	"Machine Learning" course by Andrew Ng on Coursera
2.	"Introduction to Machine Learning (IITKGP)" by Prof. Sudeshna Sarkar, on Swayam
3.	"Machine Learning A-Z (Python & R in Data Science Course)" on Udemy
Useful	Reference Links:
1.	"Linear Discriminant Analysis", https://sebastianraschka.com/Articles/2014_python_lda.html
2.	"Principal Component Analysis versus Linear Discriminant Analysis", https://medium.com/analytics-vidhya/illustrative-example-of-principalcomponent-analysis- pcavs-linear-discriminant-analysis-lda-is-105c431e8907
3.	"A gentle introduction to K-fold cross validation", https://machinelearningmastery.com/k-foldcross-validation/
4.	Grid search for model tuning", https://medium.com/analyticsvidhya/illustrative-example- ofprincipal-component-analysis-pca-vs-lineardiscriminant-analysis-lda-is-105c431e8907
5.	"Regularization in Machine Learning", https://towardsdatascience.com/regularization- inmachine-learning76441ddcf99a

Cod	e	Category	L	Т	Р	С	I.M	E.M	Exam
B19CSC	DE08	OE	3	0	0	3	25	75	3 Hrs.
				•	•				
			IN	ITERNI	ET OF 1	THINGS			
				(Offer	ed by C	SE)			
				(Offered	l to CE	& ME)			
Course (Objecti	ives:							
1.	To un	derstand buil	ding bloc	ks of IoT					
2.	To Kr	now various a	rchitectu	res and p	rotocols	in IoT			
3.	To use	e cloud servio	ces for dat	ta analyti	ics in Io	Г applicat	ions		
4.	To de	velop IoT app	plications	using A	rduino				
Course O	utcom	es: At the en	d of the c	ourse Sti	udents w	ill be able	e to		
S.No				Outc	ome				Knowledge Level
1.	Comp	are and contr	ast variou	is IoT ar	chitectu	es			K3
2	Identi	fy the open s	ystems in	nterconr	nection	ayers			K2
3	Imple	ment IoT app	olications	using Ar	duino				K3
4	Apply	<mark>v va</mark> rious com	municatio	on protoc	cols in Ic	т			K3
5.	Analy	se data in Io	Г applicat	io <mark>ns u</mark> sir	ng cloud	services			K4
	17			ICIN.			2011	CCC.	
	1			SY	LLABU	S		EGE	
UNIT-I (9 Hrs)	char leve of th Dev Intro Beh	els and deplo he IoTs, M2M vices. oduction to	EloT, Phy yment ter M Commu IoT Arcl twork Ar	rsical des nplates, unication hitecture chitectur	ign of Io Internet , Examp s: IoT	oT, Logica of Things les of IoT Network	al Design s Technol s, Design Architect	of IoT, IoT logy, behind Principles sure and D	oT definition, protocols, IoT d IoTs Sources For Connected esign, Drivers oneM2M IoT
UNIT-II (9 Hrs)	capa		nmunicat	ion Tecl	hnologie	s, Data I	Enrichme	nt and Con	and High-level asolidation and
UNIT-III (10 Hrs)	Wel prot Prog Ard	b Communic cocols for Con gramming w	cation pr nnected D ith Ardu C progran	otocols Devices, V ino: Fea nming c	for Cor Web Cor tures of oncepts	nnected I nnectivity Arduinc for Ardu	Devices, for conne , Compo ino, Traf	Message C ected-Devic onents of A	ected-Devices, Communication es. Arduino board, system, DHT

UNI7 (9 H	devices with limited resources. Dynamic routing protocols for wireless adhoc networks
UNI' (9 H	
Text	Books:
1.	Internet of Things: Architecture, Design Principles and Applications, Rajkamal, McGraw Hill Higher Education. 2017
2.	Internet of Things - A Hands-on Approach, ArshdeepBahga and Vijay Madisetti, Universities Press, 1 st edition, 2014.
Refer	rence Books:
1.	Designing the Internet of Things, Adrian McEwen and Hakim Cassimally, Wiley, 1 st edition, 2014.
2.	Getting Started with the Internet of Things CunoPfister, Oreilly. 2011
3.	Getting Started with Raspberry Pi, Matt Richardson & amp; Shawn Wallace, O'Reilly (SPD),2014.
	ENGINEERING COLLEGE
e-Res	ources: Estd. 1980 AUTONOMOUS
1.	Introduction to Internet of Things, https://swayam.gov.in/nd1_noc20_cs66/preview
2.	An Introduction to Programming the Internet of Things(IoT) specialization, https://www.coursera.org/specializations/iot

	Code Category L T P C I.M E.M Exam B19CSOE09 OE 3 0 0 3 25 75 3 Hrs.												
B19	B19CSOE09 OE 3 0 0 3 25 75												
OPERATING SYSTEMS													
(Offered by CSE)													
	(Offered to CE, ECE, EEE & ME)												
Cour	Course Objectives:												
1.	Intro	duce to	the internal of	operation	of moder	n operati	ng systei	ns					
2.	Defin	ne, expl	ain, process	es and th	nreads, mu	itual exc	lusion, C	CPU schee	duling, c	leadlock, memory			
		•	t, and file sys										
3.			File Systems	-									
4.			Input Output	t Manage	ement and	use of E	Device D	river and	Seconda	ary Storage (Disk)			
		anism											
5.	Anal	yze Sec	urity and Pro	otection I	Mechanism	n in Oper	ating Sy	stem					
Cour	se Ou	tcomes	: At the end	of the co	urse Stude	nts will l	be able to)					
S.No			63		Outcome					Knowledge			
	Dag	mileo		notiona	of Operat	ing Sug	tom on	1 function	an of	Level			
1.		rating S	arious gene	Tations	or Operat	ing sys	tem and	i function		K2			
	-		e concept of	program	n process	and thre	ad and	analyze ya	arious				
2.			uling Algorit		-					K2			
2			r Process						atical	1/2			
3.			y various me			AUTU	arh la rh			K3			
	Con	npare v	arious Mem	ory Mar	agement	Schemes	especia	lly paging	g and				
4.	-		on in Operat	ting Syst	tem and a	pply var	ious Pag	e Replace	ement	K3			
		nniques											
5.	Outl	ine File	e Systems in	Operatin	g System l	ike UNI	X/Linux	and Wind	OWS	K2			
				-		LABUS							
		_			-			-		system structure,			
UNI		-		-	_	-		-	-	perating Systems.			
(10 H	(rs)	•		-				-	-	System Interface,			
		•	• 1		•	•	em prog	grams, op	erating	system structure,			
		operati	ng system de	bugging	, System E	600t.							
	I	Droca	Correct	Due of	and ache	lulin ~	Onomatio	n a or	n #0.0207	og Inter process			
		Proces	ss Concept unication, Co			0	Operation of the system		process	es, Inter-process			
UNI	гп						•		broriog	Threading issues			
(10 H				-		-				Threading issues. gorithms, Multiple			
			sor schedulir	-	-				uning all	501101116, WIUIUPIC			
		-		-		-	ons Criti	cal Regio	ns Mut	ual exclusion with			
			process COII	munica	non. Race	conunt	nis, chili	car Kegio	115, Iviul	uai exclusion with			

	busy waiting, Sleep and wakeup, Semaphores, Mutexes, Monitors, Message passing, Barriers, Classical IPC Problems - Dining philosophers problem, Readers and writers problem.						
UNIT-I (10 Hrs	Virtual Memory Management: Introduction Demand naging conv on-write Page						
UNIT-I (10 Hrs							
	Secondary-Storage Structure : Overview of disk structure, and attachment, Disk scheduling, RAID structure, Stable storage implementation.						
UNIT-` (10 Hrs							
Text Bo	nks.						
ICAT DO	Silberschatz A, Galvin P B, and Gagne G, Operating System Concepts, 9th edition, Wiley,						
1.	10 C + + + C / +						
2.	2013.AUTOMOMOUSTanenbaum A S, Modern Operating Systems, 3rd edition, Pearson Education, 2008.(forInterprocess Communication and File systems.)						
Referen	ce Books:						
1.	Dhamdhere D M, Operating Systems A Concept Based Approach, 3rd edition, Tata McGraw- Hill, 2012.						
2.	Stallings W, Operating Systems -Internals and Design Principles, 6th edition, Pearson Education, 2009						
3.	Nutt G, Operating Systems, 3rd edition, Pearson Education, 2004						
e-Resou	rces:						
1.	https://nptel.ac.in/courses/106/105/106105214/						

0	ode	Category	L	Т	Р	C	I.M	E.M	Exam									
B19E	COE05	OE	3			3	25	75	3 Hrs									
				1	1		1		•									
		II	NTERNE	ET OF '	THINGS	5												
			(Offer	ed by I	ECE)													
			Offered	to CE,	& ME)													
Course	Objectives																	
1.		students familiar	with the	basic	concepts	s of M2	M &IoT a	rchitectu	re and									
	Communication protocols.To introduce the Python Scripting Language with Raspberry PI platform, that is widely																	
2.		Γ applications.	ipting La	nguage	with Ra	spberry	PI platform	, that is	widely									
3.		ce the implementat	ion of we	h_hase	1 service	s on IoT	devices											
5.	10 milodu	ee the implementat		0-0ase		3 011 10 1												
Course	Outcomes:	At the end of the c	ourse Sti	idents v	vill be ab	le to												
					, iii o'o uo	10 10		Kno	wledge									
S.No			Outco	ome					evel									
1.	Explain the	e architecture and c	ommunio	cation p	rotocols	of IoT.]	K2									
2.	Understand	d IoT sensors an	d techno	ological	challen	ges face	ed by IoT		K2									
2.		ith a focus on wirel							112									
3.		out Python with th	e help of	Raspbe	erry Pi fo	r prepari	ng projects]	K3									
	designed for		l davia	a through	uch the	aland	uning data											
4.	analytics.	lata from physica	ii device	es uno	ugn me	cioud	using data]	K4									
	Est	d. 1980		AUT	ONOM	OUS												
			SY	LLABU	JS													
	Embeo	dded hardware uni				em, Emb	edded softw	are in a	system,									
UNIT		ples of embedded			-				-									
(09 Hr	s) advan	advanced architectures, I/O types and examples, Serial Bus communication protocols,																
	Paralle	el bus device protoc	cols,															
		<u> </u>	• • • •	·				15 :										
UNIT-		efinition, Character			-	-	-	-										
(09 Hr	S)	rotocols, M2M, Di for IoT.	iterences	and Si	milaritie	s betwee	n M2M and	1 101, 3	SDN and									
	Basic	building blocks of	an IoT D	evice.	Sensors li	ike ultras	onic. IR ser	isor. tem	perature									
UNIT-	III & hun	nidity etc., commu							-									
(08 Hr	WAN	6LoWPAN																
UNIT-	V	uction to Arduino																
(10 Hr	Progra	amming – Python p	-					erfacing	external									
	gadget	ts like ultrasonic, II	k sensor,	temper	ature & l	iumidity.		gadgets like ultrasonic, IR sensor, temperature & humidity.										

ти	IOT Physical Servers, Cloud Offerings & Data Analytics for IOT Web Application								
	Messaging Protocol (WAMP), Cloud based communication, Data Analytics, IoT								
HIS)	Design Methodology with a use.								
Books	:								
Embe	edded System Architecture Programming and Design, Raj Kamal, 2nd Edition, McGraw								
Hill.									
Intern	net of Things: A Hands-On Approach, ArshdeepBahga, Vijay Madisett								
ence E	Books:								
Embe	edded Software Primer, David Simon, Pearson								
Intern	net of Things: Principles and Paradigms by RajkumarBuyya, Amir VahidDastjerdi.								
ources	5:								
https:	://www.youtube.com/watch?v=kOjdExBUqAI								
https:	://www.codemag.com/article/1607071/Introduction-to-IoT-Using-the-Raspberry-Pi								
	Embo Hill. Intern ence H Embo Intern ources https								

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Co	ode	Category	L	Т	Р	С	I.M	E.M	Exam		
B19E	COE06	OE	3		-	3	25	75	3 Hrs		
				VLS	I DESIC	GN					
				(Offer	ed by E	CE)					
				(Offer	red to E	EE)					
Course	e Objecti										
1.	To introduce various fabrication steps of MOS transistors and their electrical properties.										
2.	-	lement the sti			•						
3.	_	lain MOS tec	hnology i	nterconn	ection as	s circuits,	, scaling n	nodels, static	and dynami		
	designs	•									
Course	Outoon	nes: The stud	anta will h	a obla ta							
Course)				Knowledg		
S.No				Outo	come				Level		
1.	Analyz	e the Electric	al propert	ies and F	abricatio	n proces	ses of MC	S circuits.	K4		
2	•	the layouts o	1 1			1			17.4		
2.	rules.	and the second							K4		
3.	-	et <mark>various s</mark> ca	-		-		-		K2		
4.	_	et the basic I					lynamic C	CMOS logic	K2		
	designs	and the impa	act of scal	ing on M	OS circu	uits.					
				C N Z			COLL	EGE			
	T 4	Estd. 1980			LLABU		DUS				
		Introduction : Introduction to IC Technology, Fabrication process: NMOS, PMOS and CMOS. Ids versus Vds Relationships, Aspects of MOS transistor Threshold Voltage,									
	MC	MOS transistor Transconductance, Output Conductance and Figure of Merit. NMOS									
UNIT	-I Inv	Inverter, Pull-up to Pull down Ratio for NMOS inverter driven by another NMOS									
(10 Hı	rs) Inv	Inverter, and through one or more pass transistors, Alternative forms of pull-up, The									
		CMOS Inverter, Latch-up in CMOS circuits, Comparison between CMO									
	CM	IOS technolog	gy.								
				· ' D · '	D		001	0/: 1 D'			
UNIT		DS and Bi-C les and Layo			-		-	-	-		
(5 Hr		uble Poly, CN					-	-			
(•		out Diagram			•			-			
	Bas	sic Circuit C	concepts:	Sheet Re	esistance	, Sheet F	Resistance	concept app	lied to MOS		
τινιτά	TTT										
UNIT- (8 Hr	trar	nsistors and Ir ay Unit, Inve		-		-	s, Standar	d unit of capa	acitance, The		

	IT-IV (Hrs)Scaling of MOS Circuits: Scaling models, Scaling factors for device parameter Limitations of Scaling on substrate doping, Miniaturization, Interconnect and conta Resistance, Subthreshold currents and current density.								
CMOS Combinational and Sequential logic circuit design:									
	Static CMOS Design: Complementary CMOS and its static properties, Ratioed logic,								
UNI									
(8 H									
	charge sharing, Static latches and registers- Latches versus registers, The bistability								
	principle, SR- Flip flops, Multiplexer based latch, Master-slave-edge triggered register.								
Text l	Books:								
1.	Essentials of VLSI Circuits and Systems By Kamran Eshraghian, Douglas and A. Pucknell								
1.	and SholehEshraghian, Prentice-Hall of India Private Limited,2005 Edition.								
2.	Digital Integrated Circuits, Jan M. Rabaey, AnanthaChandrakasan and Borivoje Nikolic,2nd								
	edition, 2016								
Refer	ence Books:								
1.	FPGA Based System Design - Wayne Wolf, Pearson Education, 2004, Technology and								
	Engineering								
2.	CMOS Digital Integrated Circuits Analysis and Design, Sung-Mo Kang, Yusuf Leblebici,								
	Tata McGraw Hill Education, 2003.								
	Links:								
1.	https://www.engineersgarage.com/vlsi-technology-an-overview/								
2.	https://www.tutorialspoint.com/vlsi_design/vlsi_design_digital_system.htm								
3.	https://www.powershow.com/viewfl/e5a26-UTONONOU5								
5.	ZDc1Z/Lecture_4_Design_Rules_Layout_and_Stick_Diagram_powerpoint_ppt_presentation								

C	ode	Category	L	Т	Р	С	I.M	E.M	Exam				
B19E	EOE01	OE	3			3	25	75	3 Hrs.				
		INTR	ODUCTI				SYSTEM	IS					
	(Offered by EEE) (Offered to CE, CSE & IT)												
			(Of	fered to	CE, CS	E & IT)							
Course	e Objecti												
1.	To stud India	y the various	aspects	of electi	ricity gen	neration a	ind powe	er generation	n scenario in				
2.		y the various a grid scenario	aspects of	transmi	ssion and	l distribut	ion of ele	ctrical energ	gy and Indian				
3.	To study	y the utilization	on of elect	ricity in	various a	application	ns.						
4.	To study	y the power co	onversion	and ener	rgy stora	ge of elec	tricity						
5.	To stud	y the electrica	l hazards,	electrica	al safety	measures	and equip	pment protec	ction devices				
Course	e Outcon	nes: At the end	d of the co	ourse Stu	idents wi	ll be able	to						
Sl.No		.0.		Outc	ome				Knowledge Level				
1.		oasic knowled in India.	ge to und	erstand j	principle	s of powe	r generat	ion and its	K3				
2.		te different co lerstand the I					ribution :	substations	K3				
3.		energy conve omponents	rsion prin	nciples t	to under	stand ope	ration of	electrical	K3				
4.		basic knowless and uninterru				ation of	rectifier	, Inverter,	K3				
5.	Unders	tand and aj al equipment.				y measur	es while	handling	К3				
				SYI	LLABUS	5							
	EL	ECTRICITY	GENER	ATION									
UNIT (10 H	IIT-I History of Electricity generation, Basic electrical quantities-Voltage, Current, Power and energy, DC and AC power supplies, frequency and rms value of sinusoidal voltage, Electric generator - principle of operation. Major sources of electricity generation:												
UNIT (10 Hi	TRANSMISSION AND DISTRIBUTION OF ELECTRICITY NIT-II Transmission of Electrical Energy: Layout of power system, Overhead lines and cables,												

	distribution, Substations - substation layout, substation equipment and their purpose.						
	Overview of Indian power grid.						
	ELECTRICAL ENERGY CONSUMPTION						
UNIT-J (10 Hr	applications DC motor - Working principle Torque equation AC motor - Working						
	fluorescent lamp, LED lamp, Electrical energy consumption in India						
	POWER CONVERTERS AND STORAGE						
	Need of power conversion, Rectifier- Single phase full wave diode rectifier with C-						
UNIT-	V filter, rectifier applications, Inverter- Single phase full bridge inverter operation,						
(10 Hr	Inverter Applications, Electricity storage- Batteries, types of batteries, Lead acid						
	battery, Li ion batteries, Ratings and basic parameters of batteries, battery pack,						
	Domestic Uninterrupted power supply (UPS) system.						
	ELECTRICAL SAFETY AND EQUIPMENT PROTECTION.						
	Hazards in electrical systems, Different types of hazards, Electric Shock, Electrical						
UNIT-							
(10 Hr	- Fuses and their ratings, Miniature Circuit Breaker (MCB), Earth Leakage Circuit						
	Breaker (ELCB), Power ratings of different domestic loads - Fans, Lights, Air conditioners, Refrigerators, etc.						
Text Bo	ooks: ENGINEERING COLLEGE						
1.	Basic Electrical Engineering- S. K. Sahdev, Pearson Publications, ISBN 978-93-325-4216-7						
2.	Dr P.S. Bimbhra, Power Electronics - 4th Edition, Kanna Publisher						
Referen	nce Books:						
1	Iqbal Husain, "Electric and Hybrid Vehicles Design Fundamentals", CRC Press, Taylor &						
1.	Iqbal Husain, "Electric and Hybrid Vehicles Design Fundamentals", CRC Press, Taylor & Francis Group, 2011						

Co	de	Category	L	Т	Р	C	I.M	E.M	Exam				
B19EE	OE04	OE	3			3	25	75	3 Hrs.				
							·	·					
			BASIC	C POWI	ER ELE	CTRONI	CS						
				(Offer	ed by E	EE)							
			(Offered	to ECE	& ME)							
Course	e Objec	tives: Student	s will lear	1									
1.	The power electronic switching devices.												
2.	The ch	naracteristics of	f power ele	ectronic	switchin	g devices							
3.	The pe	erformances of	uncontrol	led AC-	DC conv	erters							
4.	The pe	erformance and	control of	f DC-DO	C conver	ters							
5.	The op	peration of DC	-AC conve	erters									
Course	e Outco	mes: At the en	d of the co	ourse Stu	idents w	ill be able	to						
Sl.No				Outo	come				Knowledge Level				
1.	Explated evice	in the principles.	e of opera	tion of t	hyristor,	modern	power ser	niconductor	К3				
2.	Illustr	ate the phase-	controlled	rectifier	s with di	fferent lo	ads.		K3				
3.	Acqui	re the knowled	lge on DC	-DC cho	ppers.				K3				
4.	Analy	se Cyclo-conve	erter and A	AC volta	ge Contr	oller conf	iguration	s.	K3				
5.	Evalu	ate the operation	on of inve	rters.	IEER	ING	LOLL	EGE	K3				
		Estd. 1980			AUTO	NOMO	US						
				SY	LLABU	S							
UNIT (10 Hi	-I tra rs) tri tri	hyristors licon Control ansistor analog ggering, gate ggering, turn- wices IGBT an	gy – Stati triggering off metho	ic V-I o , Tempo ods-load	character erature t commu	istics of riggering, tation, lii	SCR – light tri	Turn on me ggering, forv	thods -dv/dt ward voltage				
UNIT (10 Hi													
UNIT- (10 H	$\frac{\mathbf{III}}{\mathbf{s}}$ St	C-DC Conver ep up and Step ductance and c	o-down ch	opper- i	-	-	-	-					

		AC-AC Converters (Cycloconverters and AC Voltage Controllers)								
UNI	Γ-IV	Single phase to single-phase step up cycloconverter and step down cycloconverter with								
(10 I	Hrs)	R and RL load-Bridge type. Operation of AC Voltage controllers with R and RL load,								
		RMS value of output voltage. Numerical Problem								
		DC-AC Converters (Inverters)								
UNI	T-V	Principle of operation of Single-phase half bridge and full bridge Inverters with R-load-								
(10 I	Hrs)	Voltage control in single phase inverter- PWM Techniques-Single pulse modulation-								
		multiple pulse modulation-sinusoidal pulse modulation.								
Text	Books	5:								
1.	Pow	er electronics - P.S. Bimbhra- Khanna Publishers, 4th Edition								
2	Pow	wer Electronics: Circuits Devices and Applications - M.H. Rashid, Prentice Hall of India,								
2.	3rd o	edition.								
Refer	ence	Books:								
1	Pow	er electronics - M.D. Singh & K.B. Kanchandhani, Tata McGraw - Hill Publishing								
1.	Con	npany, 2nd edition								
2.	Pow	er Electronics – Vedam Subramanyam, New Age International (p) Limited, Publishers.								
3.	Pow	er Electronics – P.C. Sen, Tata McGraw-Hill Publishing.								
4	Thy	ristorised power Controllers – G.K. Dubey, S.R Doradra, A. Joshi and R.M.K. Sinha,								
4.	New Age international Pvt Ltd. Publishers latest edition									
e-Res	source									
1.	https	s://www.youtube.com/watch?v=1Auay7ja2oY								
2.	https	s://nptel.ac.in/courses/108/105/108105066/								
		Estd. 1980 AUTONOMOUS								

C	Code	Category	L	Т	Р	C	I.M	E.M	Exam
B19E	EOE06	OE	3			3	25	75	3 Hrs
	Ν	IATLAB PRO	OGRAMM	IING FO	OR ENG	INEERI	NG APPI	LICATIONS	
				(Offer	red by E	EE)			
			,	red to C	CE, CSE,	IT & M	E)		
1		tives: Students							
1.		he MATLAB b				-	-	otting comma	inds.
2.		onal and loopin	0			-	0		
3.		he different sta				-		U U	
4.		he MATLAB p	0	ng to sol	lve engin	eering sy	stems des	cribed by the	
-		atical equation		6		.1 1			
5.	About t	he MATLAB p	programmi	ng for n	umerical	methods.			
<u>C</u> -	0.1	A (1	1 - 6 4		.1	11. 11	4 -		
Cours		mes: At the en	d of the co	ourse Stu	dents wi	li be able	to		Unowlodge
S.No					come				Knowledge Level
1.		he built-in fun tion <mark>s in MAT</mark> L			rations, j	olotting c	ommands	, arithmetic	К3
2.	Appl	y t <mark>he condition</mark>	al and loop	oing state	ements to	o wri <mark>te M</mark>	ATLAB p	programs.	K3
3.	Appl MAT	y d <mark>ifferent st</mark> at LAB.	istical app	oroaches	for bette	er interpr	etation of	data using	К3
4.		y MATLAB pr ematical equation	-	g to solv	ve engine	ering sys	tems desc	ribed by the	К3
5.	Appl	y MATLAB pr	ogrammin	g for nu	merical n	nethods.			K3
				SY	LLABU	5			
	IN	TRODUCTI	ON TO M	ATLAB	6				
 UNIT-I functions, creating vectors, matrices, manipulation of vectors and matrices, Matrix Operations, addition, subtraction, multiplication, transpose, Inverse, Determinant Identity matrix, using simple xy Plotting Functions, line plots, subplots, bar plots, surface plots, pie plots, Saving and loading data. 								rices, Matrix Determinant,	
	Ν	IATLAB PRO	OGRAMM	IING					
UNIT-II Program Design and Development, Relational Operators and Logical Variables, Log									ables, Logical
(10 H		perators, If sta /hile Loops, D							_
TINIT				T T/TX7 A					
UNIT (10 H		TATISTICS, I tatistics and H						lode, Median	and Standard

		Deviation, Uniformly Distributed Numbers, Normally Distributed Random Numbers,								
	Generating Random Integers, Interpolation, Two-Dimensional Interpolation, curfitting using least square method.									
		fitting using least square method.								
		SOLVING EQUATIONS								
UNII	г њ	Linear algebra, Rank, Eigen values, Eigen vectors, Linear algebraic equations solving								
(10 H		using matrices (up to three variables), Gauss elimination method, Matrix inverse method,								
(101	115)	quadratic equation, ordinary differential equation (upto second order), solution of partial								
		differential equation (two variable).								
		NUMERICAL METHODS								
UNI	T-V	Gauss Seidel method, Newton Raphson method for solving nonlinear equations,								
(10 H	Hrs)	Rungekutta-4 method for solving ordinary differential equations, Trapezoidal method for								
		solving numerical integration.								
Text]	Books	5:								
1	MA	TLAB and Simulink Crash Course for Engineers by Eklas Hossain, Oregon Institute of								
1.	Tec	hnology Klamath Falls, OR, USA, Springer publication, 2022.								
2.	App	blied Numerical Methods Using MATLAB, by Won Young Yang Chung, Wenwu Cao,								
Ζ.	Tae	-Sang Chung, John Morris, A John Wiley & Sons, Inc., Publication, 2005								
Refer	ence	Books:								
1.	MA	TLAB ® for Engineering Applications by William J. Palm III, Fourth edition, New York,								
1.	NY	: McGraw-Hill Education, 2018.								
C	MA	TLAB Programming for Engineers, Stephen J.Chapman, third edition, Thomson Learning								
2.	pub	lication, 2005.80 AUTONOMOUS								

Sub	oject Code	Category	L	Т	Р	С	I.M	E.M	Exam					
B 1	B19ITOE05 OE 3 3 25 75													
	CLOUD COMPUTING													
	(Offered by IT) (Offered to CE, ECE, EEE & ME)													
			(Offer	red to CE	C, ECE, I	EEE & N	IE)							
Cou	rse Objectives:													
1.		The student will learn about the basic of cloud environment, building software systems and components that scale to millions of users in modern internet cloud concepts capabilities												
2		ent will learn ab					-	-						
3.	platform		about de	eveloping	cioua c	ased sor	tware app	oncations of	on top of cloud					
4.	-	s. ent will learn ab	out the c	loud gove	ernance a	nd Securi	ity issues	in Cloud F	nvironment					
	The stud			Iouu gove			ity issues							
Сош	rse Outco	nes: At the end	of this c	ourse, the	students	will be a	ble to							
			51 0115 0	,					Knowledge					
S.No				Outco	ome				Level					
1	Understa	nd the cloud env	vironmen	it					K2					
2	Explain	Saa <mark>S and Paa</mark> S s	ervic <mark>es</mark>						K2					
3	Understa	n <mark>d an</mark> d lea <mark>rn v</mark> ai	ious Clo	ud based	Services				K2					
4	Understa	nd cloud-based	applicati	ons and v	veb appli	cations.			K2					
5	Understa	nd the concep	ts of se	ecurity, g	overnanc	e, and	Economic	s in Clou	ıd K2					
	computi	ig. Estd. 1980			AUTO	NOMO	US							
		Estu: 1700		a a										
	.							T C	•					
							-		ructure services,					
UNI	I-I stor	-I storage applications, database services – introduction to SaaS, PaaS, IaaS, IdaaS, data storage in cloud, Virtualization: enabling technologies, types of virtualization, server												
(12H	rc)	virtualization, desktop virtualization, memory virtualization, application and storage												
		ualization, tools	-			-			C					
	-													
UNI			-		with Saa	S, Softw	are plus	Services -	Overview SaaS					
(8 H	(rs) solu	tions, SOA, Paa	as and be	enefits.										
						1' * *								
UNIT						-	-		mance for load					
(10H	rs)	age, and backup	-		-				cloud based data					
	5101	uze, and vaerup	501 11008	, ciouu Da	1300 0100	r storage	and uala							
	Cle	ud Application	develor	oment: C	lient serv	er distrib	uted archi	tecture for	cloud designing					
UNIT			-						vs cloud Apps,					
(10H				•					Web APIs, Web					
	Bro	wsers.												

		Cloud Governance and economics: Securing the cloud, disaster recovery and business						
UN	IT-V	Continuity in the cloud, Managing the cloud, migrating to the cloud, governing and						
(10	Hrs)	evaluating the clouds business impact and economics, Inside Cloud: Introduction to						
		MapReduce and Hadoop over view of big data and its impact on cloud.						
		·						
Te	xt Bool	κs:						
1.	Cloud	Computing: SaaS, PaaS, IaaS, Virtualization, Business Models, Mobile, Security and More,						
1.	Kris J	amsa, Jones & Bartlett Publishers, Paper back edition,2013.						
2	Cloud	Computing: A Practical Approach, Anthony T .Velte, Toby J.Velte, Robert Elsenpeter, Tata						
2.	2. McGraw Hill Edition.							
Re	ference	e Books:						
1.	Hado	op MapReduce cookbook, SrinathPerera and ThilinaGunarathne, Packet publishing						



Sul	bject Co	de	Category	L	Т	Р	С	I.M	E.M	Exam
B 1	I9ITOE	06	OE	3			3	25	75	3 Hrs.
					1		•	•	1	
				IN	TERNE	ET OF TH	HINGS			
					(Offe	red by I	Г)			
				(Offered	to CE &	ME)			
Cou	rse Obje									
1			d not object							
2			ut design pri			evices				
3			IoT related p							
4			d the data li				<u></u>			
5	To unc	lerstan	d data analy	tics and	cloud in	context o	of lol			
Carr	nao O 4	0000000	Du tha and	of the st		o otredonet	hould be	to the ability	u to:	
Coul		omes	By the end	or the co	Juise, in	e student	should hav		y 10:	Knowledge
S.No					Outo	come				Level
1	Eval	uate th	ne concept of	f Interne	t of Thin	ngs in diff	erent conte	exts.		K4
2			d about desig			-		7 -		K2
3	Ana	yze va	arious protoc	cols of Ic	T.					K4
4	Iden	tify the	e need of dat	ta link la	ye <mark>r in</mark> Io	T.				K2
5	App	ly data	analytics ar	nd cloud	offering	s related	o IoT.	ALLE/		K3
		X	Ser and a ser a se	-	AGIU	IEER	INGU	ULLEU	32	
		Es	td. 1980		SYI	LLABUS	NUMUL	15		
				_				-		ctural view,
					-	-	-			IoTs, M2M
(81			ble smart wa					pment tool	s, Examp	les of IoTs:
		veara				, smart en	105.			
]	Design	Principle	s for C	onnecte	d Devic	es IoT/M2	2M system	s LAYEF	RS AND
TINI		0	s standardiza					•		
	T-II Hrs)	lomair	ns and Hig	gh-level	capabili	ities, Co	mmunicati	on Techno	ologies: B	luetooth,
(10)		Zigbee	e, Wi-Fi, D	Data En	richment	and Co	onsolidatio	n and De	evice Mar	nagement
	(Gatewa	ay, Ease of c	lesigning	g and aff	ordability	•			
	I .		D · · · ·	P	41					•
		Design	-				•			evices Web
UNI	1-111		-							ased on the
(9 I	-rs)				-			-		etwork using
			REST and H	-						und and and
UNI	T-IV	Data li	ink layer of	f IoT, W	ireless C	Communio	cation Tecl	nnologies, V	Wired Cor	nmunication
	I									

(8 H	(rs)	rs) Technologies, Manet Networks: Network Layer of IoT, 6lowPAN adaptation layer for								
		devices with limited resources, Dynamic routing protocols for wireless adhoc networks								
		Data Acquiring, Organizing and Analytics								
		Data Acquiring and Storage, Organizing Data, Transactions, Business Processes,								
UNI	Г-V	Integration and Enterprise Systems. Data Collection, Storage and Computing Using a								
(10 H	Hrs)	Cloud Platform, Cloud computing paradigm for data collection, storage, and								
		computing, cloud service models: IOT based cloud based services using Xively,								
Nimbits										
Textb	ooks:									
1	Intern	net of Things: Architecture, Design Principles And Applications, Rajkamal, McGraw								
1	Hill Higher Education.									
2	Intern	nternet of Things, A.Bahgya and V.Madisetti, University Press, 2015.								
2	3 Internet of Things from Hype to Reality: The road to Digitization, Ammar									
RayesSamersalam.										
Refer	ence H	Books:								
1	Desig	Designing the Internet of Things, Adrian McEwen and Hakim Cassimally, Wiley.								
2	Getti	ng Started with the Internet of Things CunoPfister, Oreilly.								
3	Intern	net of Things and Data Analytics Handbook, HWAIYU GENG, Wileypublications.								
L										



Code	CodeCategoryLTPCI.ME.M									
B19MEC	DE05	OE	3			3	25	75	3 Hrs.	
					IATRO					
					red by N	-				
			(Offered	to CE,	CSE, EC	CE, EEE	& IT)			
Course C	v									
	To equip the students with fundamental knowledge on mechatronic systems.To familiarize the student with interdisciplinary knowledge of electronics required for									
)		on in mechani			aisciplina	iry know	ledge of	electronics	required for	
apţ	meane		cal engine	ering.						
Course (Jutcor	nes: At the en	d of the c	ourse st	udents w	ill be able	e to			
									Knowledge	
S.No				Outo	come				Level	
1. U	nders	tand about	various ty	pes of	sensors,	transdu	cers and	amplifiers	K2	
aj		in a mechatro							K2	
.)	-	y the use of	-		-	gates an	d actuati	on systems	K2	
		l for the desig					ing the f	in dom ontol		
i		te mathemati		is for pr	iysical s	stems us	sing the I	undamental	К3	
D		•		first and	second	order sv	stems wit	h feedback		
4.	oops.	evelop transfer function of first and second order systems with feedback K3								
5. D	Develop the knowledge on microcontrollers programmable logic controllers							K3		
and their applications in mechatronic systems.						IX.5				
				0.57		9				
	Trad	madration to	Machata		LLABU	5				
		Introduction to Mechatronics: Sensors &Transducers: Introduction, performance terminology, Classical Sensors & Transducers Sensors Sen								
	sen	sensors: Potentiometer sensor, strain gauged element, Capacity element, L								
UNIT-I	Ene	Encoders, Selection of sensors.								
(10 Hrs)	Sig	Signal Conditioning: Introduction signal Conditioning-Operationa							-	
		Inverting amplifier, summing amplifier, Integrating amplifier, Differen								
	filt	ering process.								
	Di	nital cignalas	Digital an	d anala~	cionala	DA and	AD conv	artar Data	Acquisition	
UNIT-II		Digital signals: Digital and analog signals - DA and AD converter – Data Acquisition Digital logic : Digital logic - Logic gates – Application of logic gates								
(10 Hrs)	, c	Pneumatic and hydraulic Actuation Systems: Direction control val								
		control valve-cylinders, Mechanical actuation systems							-	
	·									
UNIT-II			·		0			cal switche	s, solid state	
(10 Hrs)	SWI	switches – solenoids - DC motors, AC motors, stepper motors								
	Ba	Basic System Models: Modeling of one and two degrees of freedom Mechanical,								

		Electrical, Fluid and thermal systems. Block diagram representations for these systems.					
		Mechanical translational systems, Mechanical rotational systems, Electromechanical					
		coupling					
		- or pring					
		System Transfer functions: The Transfer function, Laplace transforms, First order					
UNI	T-IV	systems, Second order systems, systems in series, systems with feedback loops.					
(10 I	Hrs)	Closed loop controllers: Continuous and discrete processes, control modes, Two step,					
		Proportional, Derivative, Integral, PID controllers					
		Microprocessors: Microprocessor systems, Micro controllers, Applications					
		PLC: Introduction, basic structure, I/P, O/P, processing, programming, ladder diagrams,					
UNI	T-V	timers, internal relays and counters, data handling, analogue input and output, selection					
(10 I	Hrs)	of PLC.					
		Case studies of Mechatronic Systems: Pick and place robot, Digital camera,					
		Automotive control					
Text	Books	5:					
1	Mec	hatronics Electronic control systems in Mechanical and Electrical Engineering by W.					
1.	Bolt	on, Pearson Education, 4th Edition, 2011					
2	Intro	oduction to Mechatronics – David and Alcaitore Michael B.Histand TMH, 4th Edition,					
2.	2006						
Refe	rence	Books:					
1	Mec	hatronics System Design by Devdas Shetty and Richard A. Kolk, P.W.S. Publishing					
1. Company, 2001 ENGINEERING COLLEGE							
Web	links:	Estd. 1980 AUTONOMOUS					
1.	https	s://nptel.ac.in/courses/112107298					
		s://nptel.ac.in/courses/112103174					

CodeCategoryLTPCI.ME.M								Exam	
B19 N	1EOE06	OE	3			3	25	75	3 Hrs.
Cours 1.	se Objec Signific	tives: cance of alternat	(Offer	(Offe red to C	red by N E, CSE,	SYSTEM IE) ECE, & I			
2.	Significance of green energy systems and processes and provides the theory and working principles of probable sources of renewable and green energy systems that are Environmental friendly.								
Cours S.No	se Outco	mes: At the end	l of the cou	orse, stud		be able to)		Knowledge
5.110				Oute	JIIIe				Level
1.	Explair	the importance	of solar e	nergy an	d solar ei	nergy coll	ection		K2
2.	-	he principles of		0.		0.			К3
3.	Apply	ply the principles of biomass, geo thermal and ocean energies & their potential K3 ure applications.							
4.	Describe the principles of energy efficient systems like electrical and mechanical K2 systems.								
5.	Discuss	the concepts of	f green ma	nufacturi	ing syste	ms.	COLLI	EGE	K2
		Estd. 1980			AUTO	<u>NOMO</u>	US		
					LLABU	-			
UNI (10 F	T-I Irs) E S	ntroduction: Re nvironmental in olar Radiation adiation on title idiation data olar Energy (oncentrating col	npact of so : the solar d surface, Collection	lar powe r constat instrume : Flat j	er. nt, extrat ents for 1 plate an	errestrial neasuring d concen	and terre solar rad	strial solar r iation and su ollectors, cla	adiation, solar in shine, solar assification of
	Solar Energy Storage and Applications: Different methods, sensible, latent heat and stratified storage, solar ponds, solar applications- solar heating/cooling technique, solar distillation and drying, central power tower concept.Wind Energy: Sources and potentials, horizontal and vertical axis windmills.								
	Bio-Mass: Principles of bio-conversion, anaerobic/aerobic digestion, types of bio-gaIT-IIIdigestersHrs)Geothermal Energy: Resources, types of wells, methods of harnessing the energyOcean Energy: OTEC, Principles of utilization, setting of OTEC plants.						-		

	Energy Efficient Systems: ELECTRICAL SYSTEMS: Energy efficient motors, energy							
UNIT	efficient lighting and control, controls for HVAC (heating, ventilation and air conditioning).							
(10 H	Mechanical Systems: Fuel cells- principle, selection of fuels & working of various types of							
	fuel cells, Environmental friendly and Energy efficient compressors and pumps.							
	Green Manufacturing Systems: Environmental impact of the current manufacturing							
UNI								
(10 E								
	casting and joining techniques, zero waste manufacturing.							
Text I	Books:							
1.	Non-Conventional Energy Sources - G. D. Rai, fifth edition, Khanna Publishers, 2015.							
2.	Non-Conventional Energy Resources - Khan B.H., Tata McGraw Hill, New Delhi, 2006							
3.	Solar Energy – Principles of Thermal Collection and Storage/Sukhatme S.P. and J.K.Nayak/TMH							
4.	Green Manufacturing Processes and Systems - J. Paulo Davim/Springer 2013.							
Refer	ence Books:							
1.	Alternative Building Materials and Technologies - K.S Jagadeesh, B.V Venkata Rama Reddy a							
1.	K.S Nanjunda Rao/New Age International							
2.	Non-Conventional Energy - Ashok V Desai /New Age International (P) Ltd							
3.	Renewable Energy Technologies -Ramesh & Kumar /Narosa							
4.	Principles of Solar Engineering - D.Yogi Goswami, Frank Krieth& John F Kreider/Taylor							
4.	Francis.							
5.	Fuel Cell Technology -Hand Book / Gregor Hoogers / BSP Books Pvt. Ltd							
	ENGINEERING COLLEGE							
Web links: AUTONOMOUS								
1.	https://nptel.ac.in/courses/103103206							
2.	https://nptel.ac.in/courses/115103123							

MICRO-ELECTRO MECHANICAL SYSTEMS (Offered by ME) (Offered to CE, CSE, ECE, EEE & IT) Course Objectives: 1 To learn basics of Micro Electro Mechanical Systems (MEMS) and study the varian materials used for micromachining techniques and to learn about various sensors a actuators used in MEMS 2. To give exposure to different MEMS Thermal Sensors And Actuators. 3. To learn the principle and various devices of MOEMS and Magnetic Sensors And Actuat devices. 4. (DEP), electro thermal flow, opto electro wetting (OEW), and thermal effects Micro fluid actuation methods, dielectrophore (DEP), electro thermal flow, opto electro wetting (OEW), and thermal effects Micro fluid and to learn Radio Frequency (RF) MEMS Course Outcomes: At the end of the course, students will be able to S.No Outcome 1. Identify the materials used for micromachining techniques and Analyze the process of sensors and actuators. K4 2. Acquire the knowledge of Heat transfer processes, Thermal effects, Devices K3 K3 3. Analyze and develop models for different types of Magnetic Sensors and magnetic sensing and detection. Develop MOEMS technology K4 Introduction: Definition of MEMS, MEMS history and development, micro machinin ithography principles & methods, structural and s	Co	ode	Category	L	Т	Р	С	I.M	E.M	Exam
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(10 Hrs)		-I Mechanical Sensors And Actuators: Principles of sensing and actuation							•	
cantilever, capacitive, piezo electric, strain, pressure, flow, pressure measurement	(10 Hr	·S)								
micro phone, MEMS gyroscopes, shear mode piezo actuator, gripping piezo actua									•	
		Inchworm technology.								iezo actuator,
men of the comology.		Inch		~01.						
Thermal Sensors And Actuators: Thermal energy basics and heat transfer process		The	rmal Sensors	And Act	tuators:	Therma	l energy	basics an	d heat trans	fer processes.
UNIT-II thermisters, thermo devices, thermo couple, micro machined thermo couple probe, pel	UNIT-									-
(10 Hrs) effect heat pumps, thermal flow sensors, micro hot plate gas sensors, MEMS ther						-			-	
vessels, pyro electricity, shape memory alloys (SMA), U-shaped horizontal and verti										

		electro thermal actuator, thermally activated MEMS relay, micro spring thermal						
		actuator, data storage cantilever.						
		Micro-Opto-Electro Mechanical Systems: Principle of MOEMS technology, properties						
UNIT	'-III	of light, light modulators, beam splitter, micro lens, micro mirrors, digital micro mirror						
(10 H	(rs)	device (DMD), light detectors, grating light valve (GLV), optical switch, wave guide and						
		tuning, shear stress measurement.						
		Magnetic Sensors And Actuators: Magnetic materials for MEMS and properties,						
UNIT	-IV	magnetic sensing and detection, magneto resistive sensor, more on hall effect, magneto						
(10 H	(rs)	diodes, magneto transistor, MEMS magnetic sensor, pressure sensor utilizing MOKE,						
		mag MEMS actuators, by directional micro actuator, feedback circuit integrated magnetic actuator, large force reluctance actuator, magnetic probe based storage device.						
		actuator, large lorce reluctance actuator, magnetic probe based storage device.						
		Micro Fluidic Systems: Applications, considerations on micro scale fluid, fluid						
		actuation methods, dielectrophoresis (DEP), electro wetting, electro thermal flow, thermo						
		capillary effect, electro osmosis flow, opto electro wetting (OEW), tuning using micro						
UNIT	Г-V	fluidics, typical micro fluidic channel, microfluid dispenser, micro needle, molecular gate, micro pumps.						
(10 H	(rs)							
		Radio Frequency (Rf) MEMS: RF – based communication systems, RF MEMS,						
		MEMS inductors, varactors, tuner/filter, resonator, clarification of tuner, filter, resonator,						
		MEMS switches, phase shifter.						
		ALEAS A						
Text I								
1.		MS, NitaigourPremchandMahalik, TMH Publishing co. US						
		Books:						
1.	Foundation of MEMS, Chang Liu, Prentice Hall Ltd.							
2.	MEMS and NEMS, Sergey EdwrdLyshevski, CRC Press, Indian Edition.							
3.	MEMS and Micro Systems: Design and Manufacture, Tai-Ran Hsu, TMH Publishers.							
4.		ductory MEMS, Thomas M Adams, Richard A Layton, Springer International Publishers.						
Web l								
1.	https	:://nptel.ac.in/courses/117105082						
2.	https	s://nptel.ac.in/courses/108108113						